

Fairchild Semiconductors Statement Regarding the Restriction of Hazardous Substances

This document is the Fairchild Semiconductor's statement with regard to the Directive 2002/95/EC of the European Parliament and of the Council on the Restriction of the use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS directive). The responses in the document are based upon information collected from Fairchild Semiconductor facilities worldwide, specifically our manufacturing sites in: South Portland, Maine, USA; West Jordan, Utah, USA; Mountaintop, Pennsylvania, USA; Loveland, Colorado, USA; Penang, Malaysia; Cebu, Philippines; Bucheon, Korea; Suzhou China; and Singapore.

Products manufactured by Fairchild Semiconductor are in compliance with the RoHS directive. Specifically, products manufactured by Fairchild Semiconductor do not contain the substances listed in the table below in concentrations greater than the listed Maximum Limit value.

Substance	Maximum Limit (ppm)
Cadmium (Cd)	100
Lead (Pb)	1000 ⁽¹⁾⁽²⁾
Mercury (Hg)	1000
Hexavalent Chromium (Cr ⁶⁺)	1000
Poly Brominated Biphenyls (PBB)	1000
Poly Brominated Diphenyl ethers (PBDE)	1000

⁽¹⁾ Applicable to FSC products with Pb-free lead finish only

⁽²⁾ Maximum limit does not apply to applications for which exemptions have been granted by the RoHS directive

Name: David Lancaster

Date: September 7, 2005

Position: Staff Environmental Engineer


FAIRCHILD
SEMICONDUCTOR
Environmental Questionnaire Disclaimer

The information provided in this environmental statement is, to our knowledge, correct as of the date indicated on this page. However, there is no guarantee to completeness or accuracy, as some information is derived from data sources outside the company. Also, there may not be information included in this statement regarding the minute amounts of dopant and metal materials contained within the electrically active or passive devices contained within the finished product.